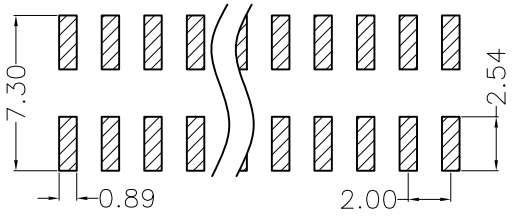
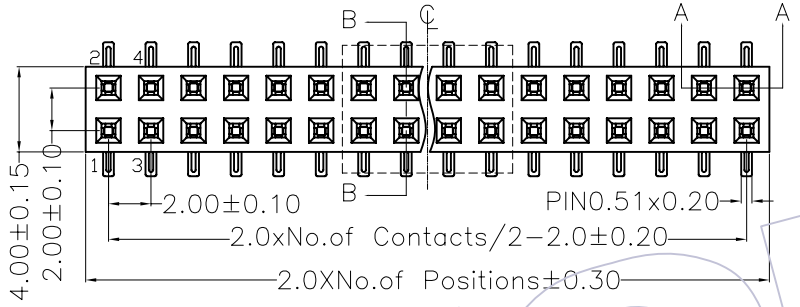
HSF

NOTES:
Current Rating: 2.0AMP
Withstand Voltage: 500V AC/DC
Contact Resistance: 20mΩ Max
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

Contact Material: Phosphor Bronze
Contact plating: Au or Sn over Ni
Insulator Material: PA6T+30%G.F UL94V-0

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

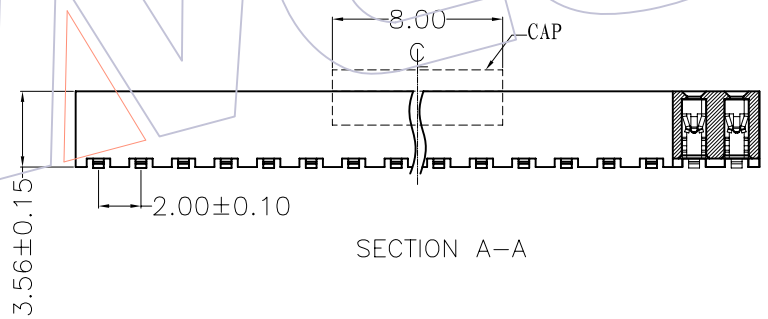




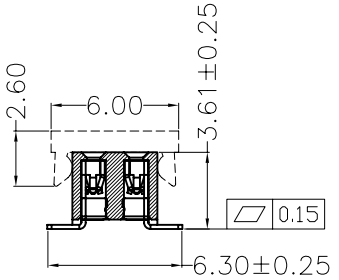
Ordering Information

2235 - 2 XX M XX CUN T 1

- XX: No.of Pins per ROW:02~40PIN
- XX: Contact Plating:
  G0=Gold Flash
  G1=3μ"Gold
  G2=5μ"Gold
  G3=10μ"Gold
  G4=15μ"Gold
  G5=30μ"Gold
  S0=Gold Flash/Tin
  S1=3μ"Gold/Tin
  S2=5μ"Gold/Tin
  S3=10μ"Gold/Tin
  S4=15μ"Gold/Tin
  S5=30μ"Gold/Tin
  SN=Tin
- T: Packing:
  T=Tube
  R=Tape&Reel+CAP
  P=Tube+CAP



SECTION A-A



SECTION B-B

WCON

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE
A0	08/02/28	NEW		

OPERATION		DRAW	MeiLiZ	08.02.28
X.X	±0.40	DESIGN		
X.XX	±0.25	CHECK		
X.XXX	±0.15	APPROVE		
Angle	± 3°			
DIM	TOL			

SCALE	3:1
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WCON 维峰五金电子有限公司
WAFE HARDWARE ELECTRONICS CO.LTD

PART NO.	2235-2XXMXXCUNT1
TITLE:	FH2.0 dual SMT H=3.56 W=4.0 high reliability socket (four point redundancy)
Customer NO.	